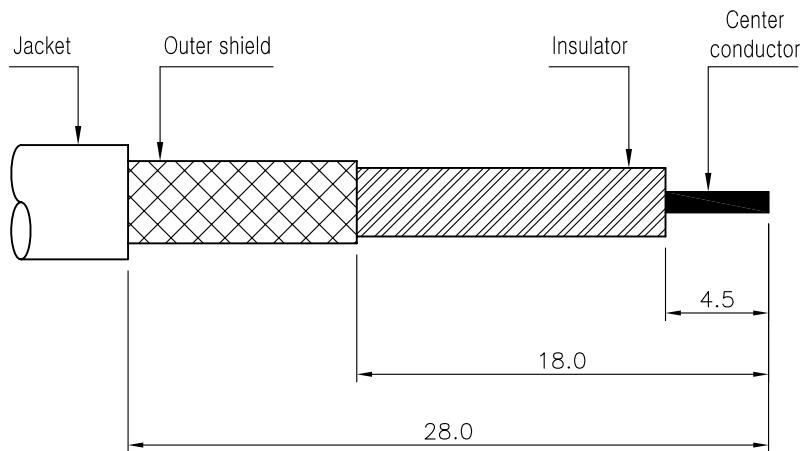
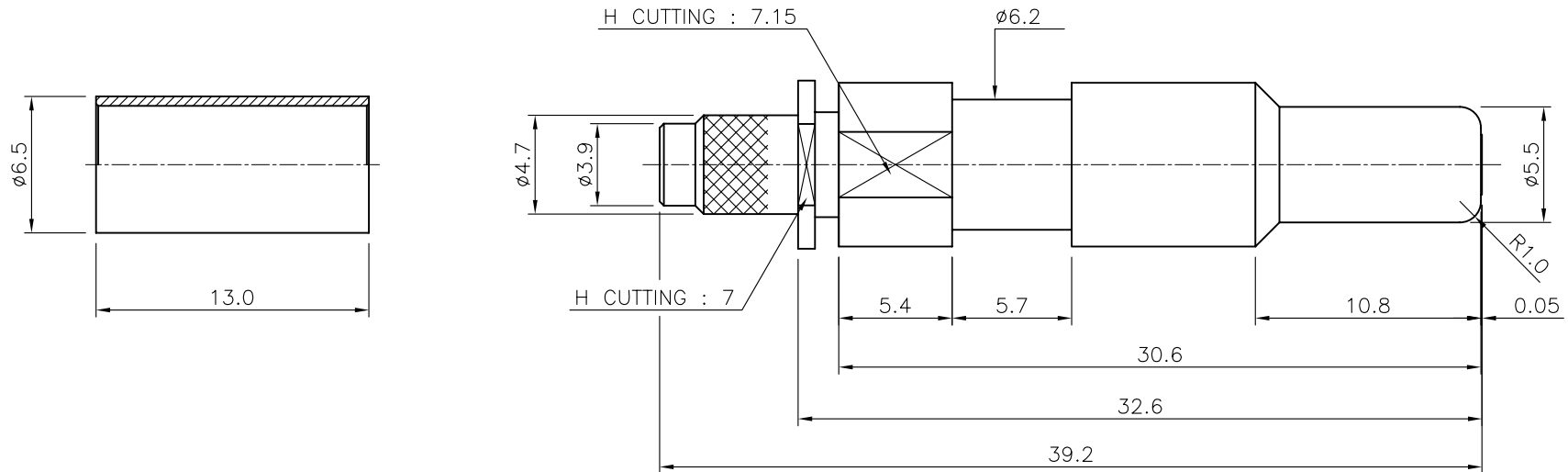


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1 R	Initial Registration	E.H.KIM	I.C.KIM	2012.10.24



CABLE 탈피도

7	INSERT	1	MBsBD	Gold Plate	DIS00194-5/1
6	BACK NUT	1	MBsBD	Gold Plate	DBN00185-5/1
5	INSULATOR	1	TEFLON		DIN02172-N/1
4	INSULATOR	1	TEFLON		DIN02168-N/1
3	FERRULE	1	MBsBD	Gold Plate	DFE00059-5/4
2	CONTACT	1	BeCu	Gold Plate	DCT02826-5/1
1	BODY	1	MBsBD	Gold Plate	DBD03182-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2012. 10. 24		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I. C. KIM	
MATERIAL	-	CHECKED BY		KJ COMTECH CO.,LTD. TITLE 기타 CABLE JS RG58 Crimp 점접조립체(발칸)
		DRAWN BY	E. H. KIM	
FINISH	-	SCALE	3/1	DWG NO. CN02882-7/2 REVISION I R SHEET 1 of 1
		UNIT	mm	